

DSF1A THRU DSF1J

1.0A Surface Mount Super Fast Rectifiers-50-600V

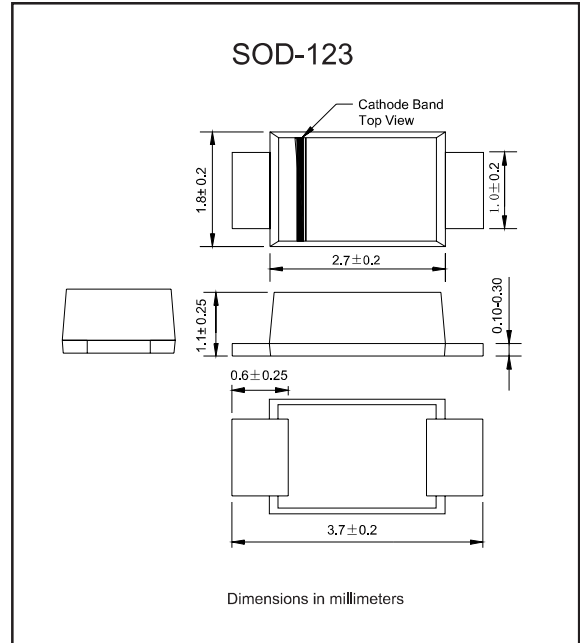
Features

- ◆ Glass passivated device
- ◆ Ideal for surface mouted applications
- ◆ Low reverse leakage
- ◆ Metallurgically bonded construction
- ◆ High temperature soldering guaranteed:
250°C/10 seconds,0.375"(9.5mm) lead length,
5 lbs. (2.3kg) tension
- ◆ Compliant to RoHS Directive 2011/65/EU
- ◆ Compliant to Halogen-free

Mechanical data

- ◆ **Case**: JEDEC SOD-123 molded plastic body over passivated chip
- ◆ **Terminals**: Plated axial leads, solderable per MIL-STD-750, Method 2026
- ◆ **Polarity**: Color band denotes cathode end
- ◆ **Mounting Position**: Any

Package outline



Maximum ratings and Electrical Characteristics (AT T_A=25°C unless otherwise noted)

PARAMETER	CONDITIONS	Symbol	MIN.	TYP.	MAX.	UNIT
Forward rectified current	See Fig.2	I _O			1.0	A
Forward surge current	8.3ms single half sine-wave (JEDEC methode)	I _{FSM}			25	A
Reverse current	V _R = V _{RRM} T _A = 25°C	I _R			5.0	μA
	V _R = V _{RRM} T _A = 100°C				50	
Thermal resistance	Junction to ambient NOTE 1	R _{θJA}		85		°C/W
Diode junction capacitance	f=1MHz and applied 4V DC reverse voltage	C _J		10		pF
Storage temperature		T _{STG}	-65		+150	°C

SYMBOLS	V _{RRM} ^{*1} (V)	V _{RMS} ^{*2} (V)	V _R ^{*3} (V)	V _F ^{*4} (V)	t _{rr} ^{*5} (ns)	Operating temperature T _J (°C)
DSF1A	50	35	50	0.95	35	-55 to +150
DSF1B	100	70	100			
DSF1C	150	105	150			
DSF1D	200	140	200			
DSF1E	300	210	300	1.25		
DSF1G	400	280	400			
DSF1J	600	420	600	1.70		

- *1 Repetitive peak reverse voltage
- *2 RMS voltage
- *3 Continuous reverse voltage
- *4 Maximum forward voltage@I_F=1.0A
- *5 Maximum Reverse recovery time, note 2

Note: 1.P.C.B. mounted with 0.2x0.2"(5.0x5.0mm) copper pad areas
2. Reverse recovery time test condition, I_F=0.5A, I_R=1.0A, I_{RR}=0.25A

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Rating and characteristic curves

FIG.1-TYPICAL FORWARD CHARACTERISTICS

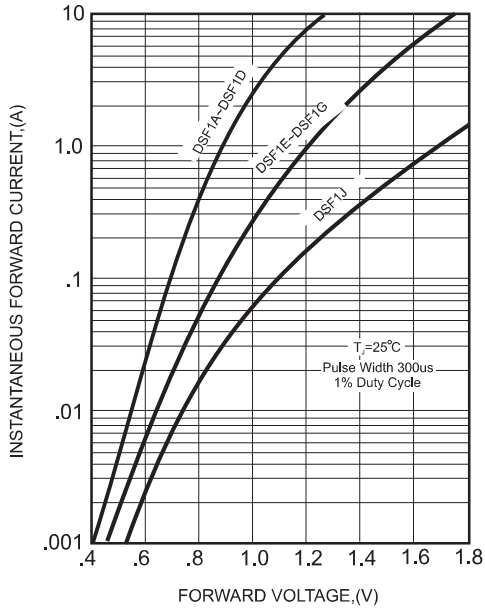


FIG.2-TYPICAL FORWARD CURRENT DERATING CURVE

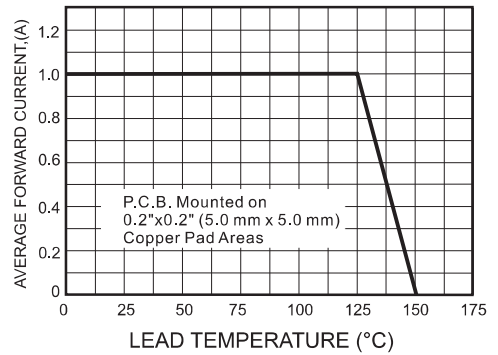


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

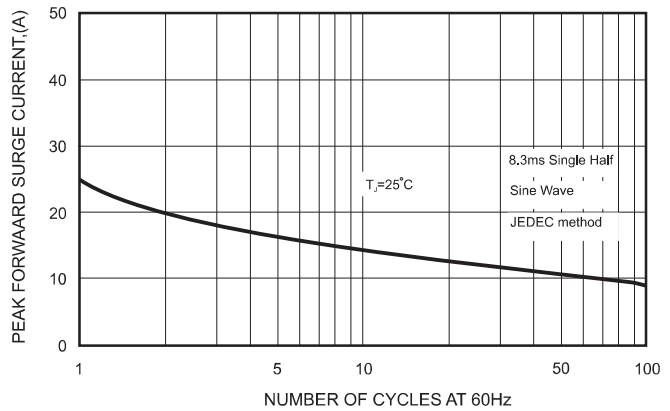
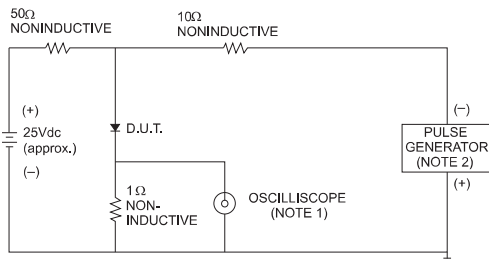


FIG.3- TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTICS



NOTES: 1. Rise Time = 7ns max., Input Impedance = 1 megohm, 22pF.
2. Rise Time = 10ns max., Source Impedance = 50 ohms.

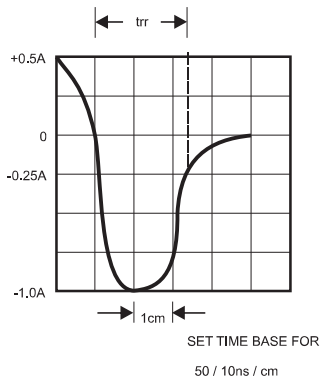
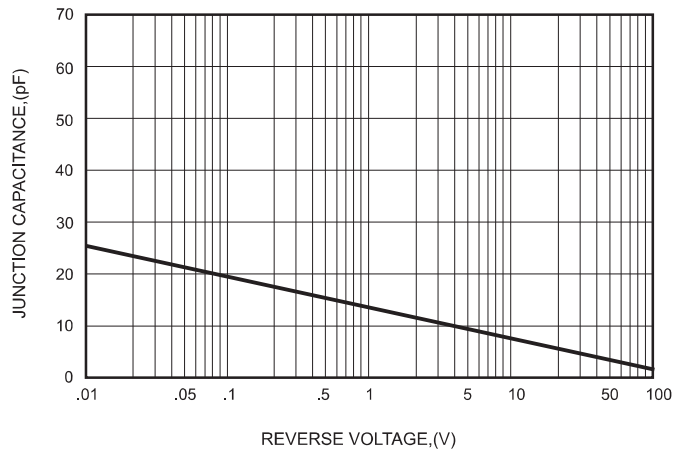




FIG.5-TYPICAL JUNCTION CAPACITANCE



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Pinning information

Pin	Simplified outline	Symbol
Pin1 cathode Pin2 anode		

Marking

Type number	Marking code
DSF1A	E1A
DSF1B	E1B
DSF1C	E1C
DSF1D	E1D
DSF1E	E1E
DSF1G	E1G
DSF1J	E1J

Suggested solder pad layout



Dimensions in inches and (millimeters)

PACKAGE	A	B	C
SOD-123	0.075 (1.90)	0.055 (1.40)	0.075 (1.90)

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